

FDD7N25LZ N-Channel UniFET[™] MOSFET **250 V, 6.2 A, 550 m**Ω

Features

- R_{DS(on)} = 430 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 3.1 A
- Low Gate Charge (Typ. 12 nC)
- Low C_{rss} (Typ. 8 pF)
- · 100% Avalanche Tested
- · Improved dv/dt Capability
- · ESD Improved Capability
- RoHS Compliant

Applications

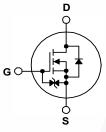
- LCD/LED/PDP TV
- · Consumer Appliances
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

FDD7N25LZ — N-Channel UniFETTM MOSFET

Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

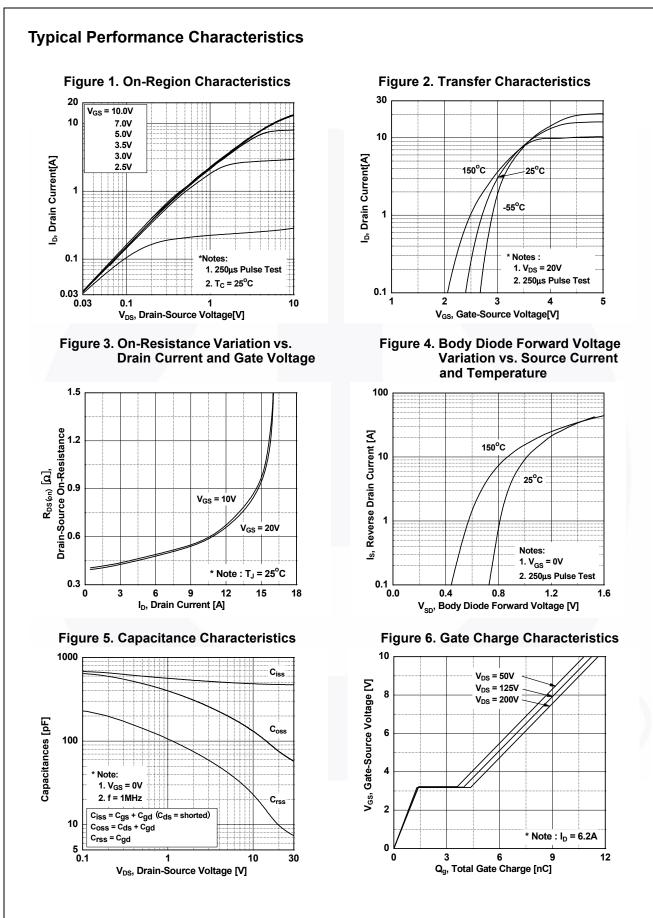
Symbol			FDD7N25LZTM	Unit		
V _{DSS}	Drain to Source Voltage		250	V		
V _{GSS}	Gate to Source Voltage			±20	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		6.2	Α	
	Drain Current	- Continuous (T _C = 100 ^o C)		3.7		
I _{DM}	Drain Current	- Pulsed (Note 1)		25	А	
E _{AS}	Single Pulsed Avalanche Energy (Note			115	mJ	
I _{AR}	Avalanche Current		(Note 1)	5.5	Α	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	5.6	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	10	V/ns	
P _D	Deven Dississeties	(T _C = 25 ^o C)		56	W	
	Power Dissipation	- Derate Above 25°C		0.45	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

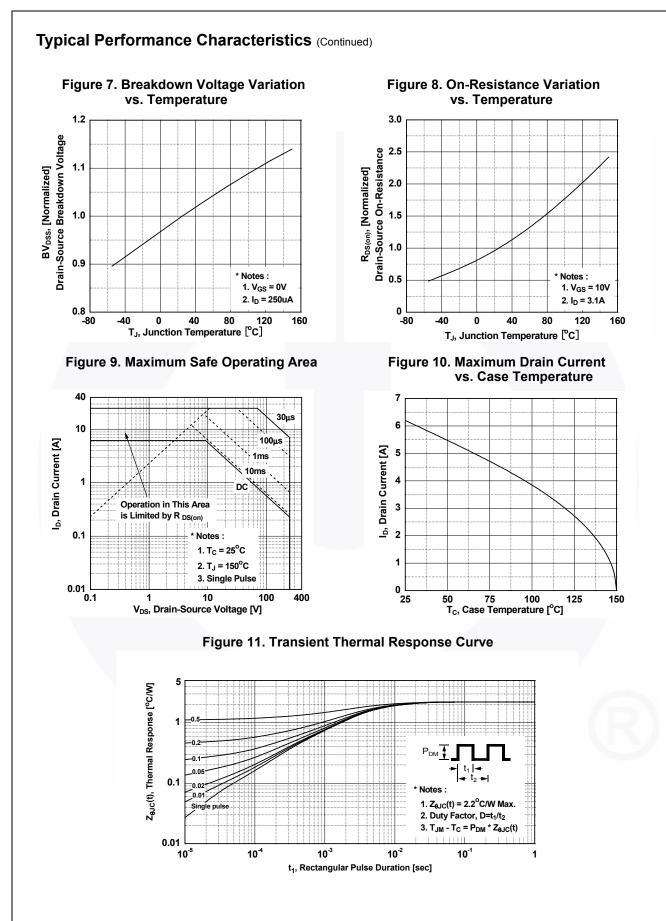
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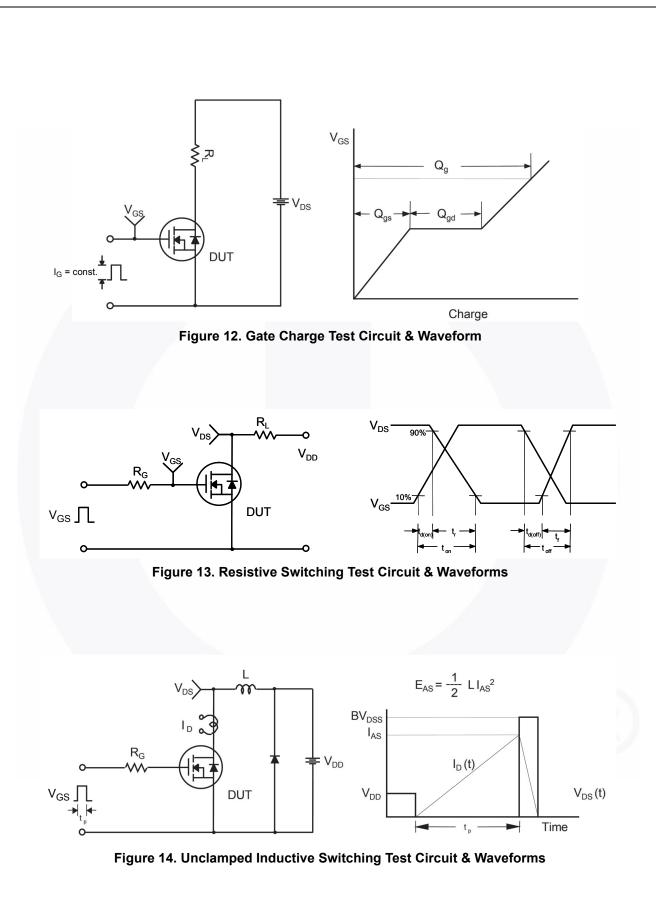
Symbol	Parameter	FDD7N25LZTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	110	0/11

Part Nu	mber	Top Mark	Packag	e Packing Method	Reel Size	e Ta	ape Width	Qu	antity
FDD7N25			DPAK	Tape and Reel	330 mm		16 mm	250	0 units
Electrica	l Chara	icteristics T _C = 25°	C unless ot	herwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV _{DSS}				= -250 + 4 + 1/2 = -0.1/1	$= 25^{\circ}$ C	250	-		V
∆BV _{DSS}	Drain to Source Breakdown Voltage Breakdown Voltage Temperature			$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V, \ T_C = 25^{\circ}\text{C}$		200	-	-	-
$/\Delta T_J$	Coefficient		1	$I_D = 250 \ \mu$ A, Referenced to 25° C		-	0.25	-	V/ºC
-	Zoro Cot	Zero Gate Voltage Drain Current		/ _{DS} = 250 V, V _{GS} = 0 V		-	-	1	
DSS	Zero Gat			$V_{DS} = 200 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	10	μA
GSSF	Gate to E	Gate to Body Leakage Current, Forward		$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$		-	-	10	μA
I _{GSSR}	Gate to E	Body Leakage Current, Re	everse \	$V_{\rm GS}$ = -20 V, $V_{\rm DS}$ = 0 V		-	-	-10	μA
On Charac	torictics								
			, ,	()() 050 A		4.0		0.5	
V _{GS(th)} C	Gate Inr	Gate Threshold Voltage		$V_{GS} = V_{DS}, I_D = 250 \mu A$		1.0	-	2.5	V
R _{DS(on)}	Static Drain to Source On Resistance		nce L	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.1 \text{ A}$		-	0.43	0.55	Ω
	Forward	Transconductance		$V_{GS} = 5 V, I_D = 3.1 A$ $V_{DS} = 20 V, I_D = 3.1 A$		-	0.45 7	0.57	S
9 _{FS}	TUIWalu	Transconductance		$v_{\rm DS} = 20 v, v_{\rm D} = 3.1 {\rm A}$		-	1	-	3
Dynamic C	haracte	ristics							
C _{iss}	Input Cap	pacitance			-	480	635	pF	
C _{oss}	Output C	apacitance		$V_{\rm DS} = 25 \text{V}, \text{V}_{\rm GS} = 0 \text{V},$		-	65	85	pF
C _{rss}	Reverse	Transfer Capacitance		f = 1 MHz	_	-	8	12	pF
Q _{g(tot)}	Total Gat	e Charge at 10V	1	V _{DS} = 250 V I _D = 6.2 A,		-	12	16	nC
Q _{gs}	Gate to S	Source Gate Charge		$V_{GS} = 10 V$ (Note 4)		-	1.5	-	nC
Q _{gd}	Gate to D	Drain "Miller" Charge				-	4	-	nC
Switching	Characte	eristics							
t _{d(on)}		Delay Time				-	10	30	ns
t _r		Rise Time	\ \	$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 6.2 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 25 \Omega$		-	15	40	ns
t _{d(off)}		Delay Time					75	160	ns
t _f	Turn-Off I	,					30	70	ns
·		Characteristics	I			7	11		
	1	e Characteristics	Iroo Diodo I	Enward Current		-		6.2	A
I _S		Maximum Continuous Drain to Source Dioc Maximum Pulsed Drain to Source Diode Fo				-	-	25	A
I _{SM}		Source Diode Forward Vo				-	-	1.4	V
V _{SD}		Recovery Time		$V_{GS} = 0 V, I_{SD} = 6.2 A$ $V_{GS} = 0 V, I_{SD} = 6.2 A,$ $dI_F/dt = 100 A/\mu s$			130	_	
t _{rr} Q _{rr}		Recovery Charge				-	0.6	-	ns
	i coreise i	Coovery charge	,			-	0.0	-	μC



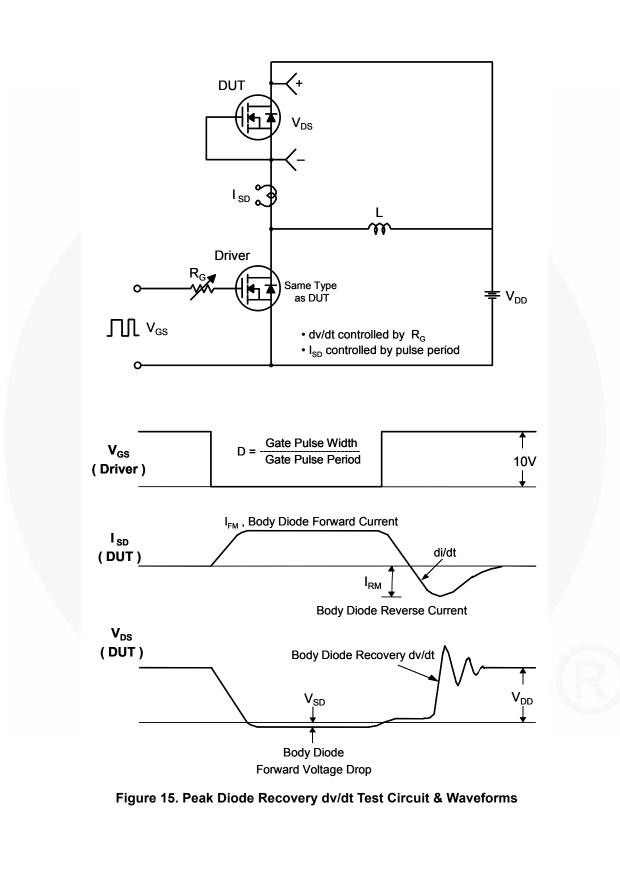
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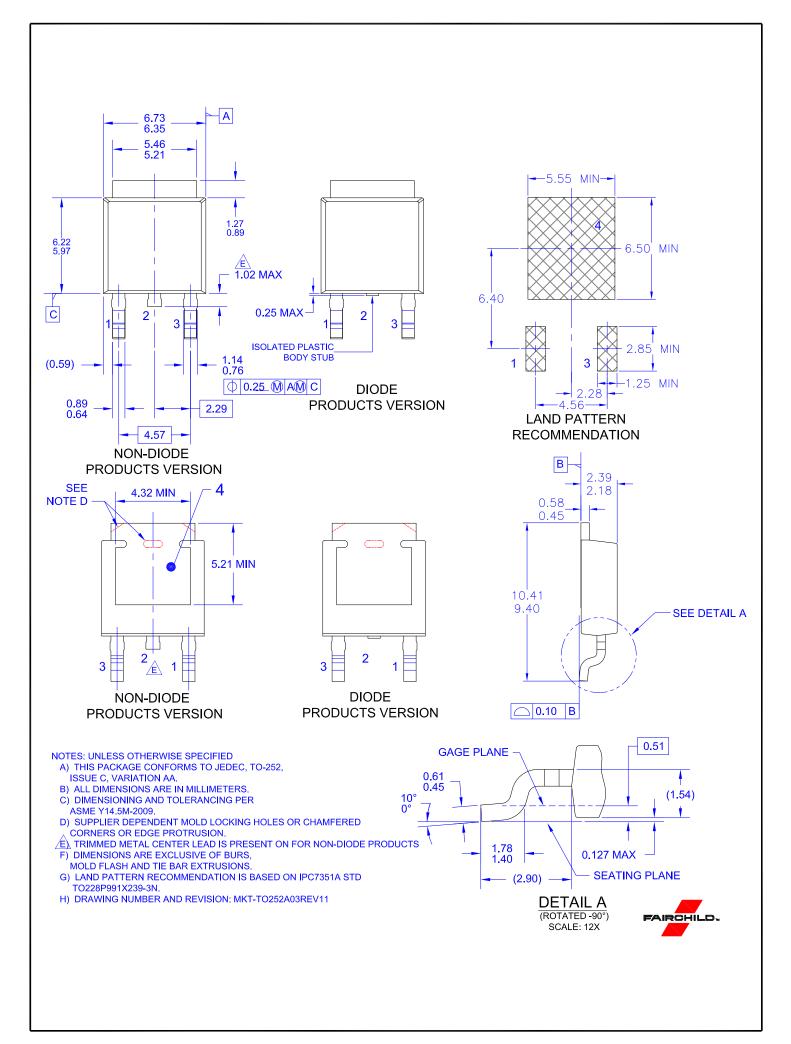




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